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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

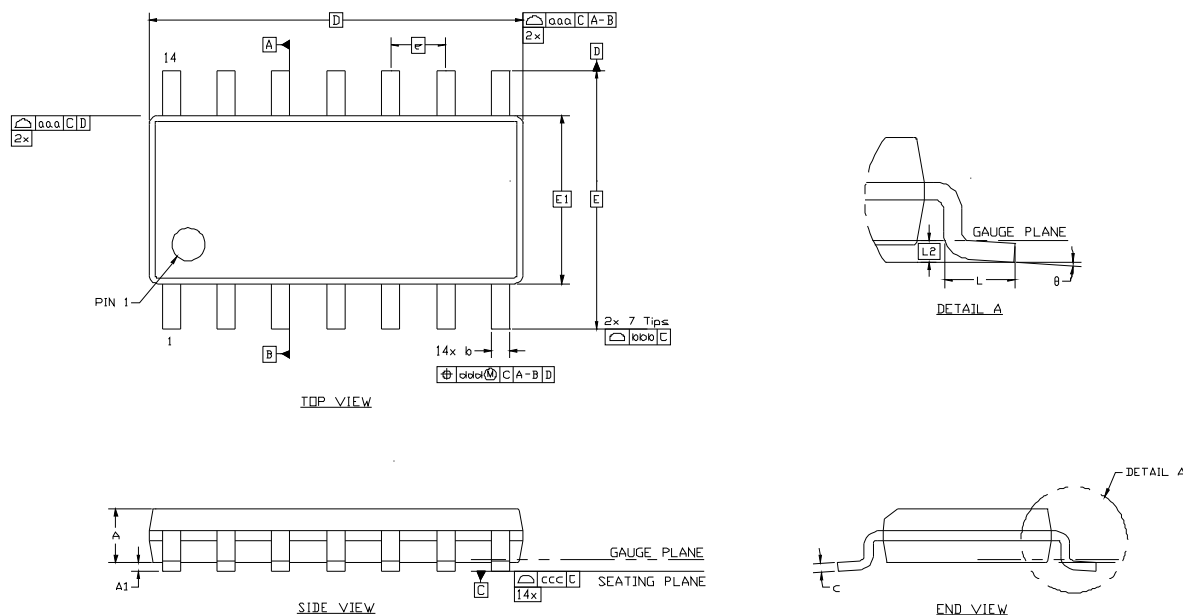
#### Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I <sup>2</sup> C), UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	8
Program Memory Size	2KB (2K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	10-VDFN Exposed Pad
Supplier Device Package	11-QFN (3x3)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/silicon-labs/c8051t605-gmr">https://www.e-xfl.com/product-detail/silicon-labs/c8051t605-gmr</a>

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## 5. SOIC-14 Package Specifications



**Figure 5.1. SOIC-14 Package Drawing**

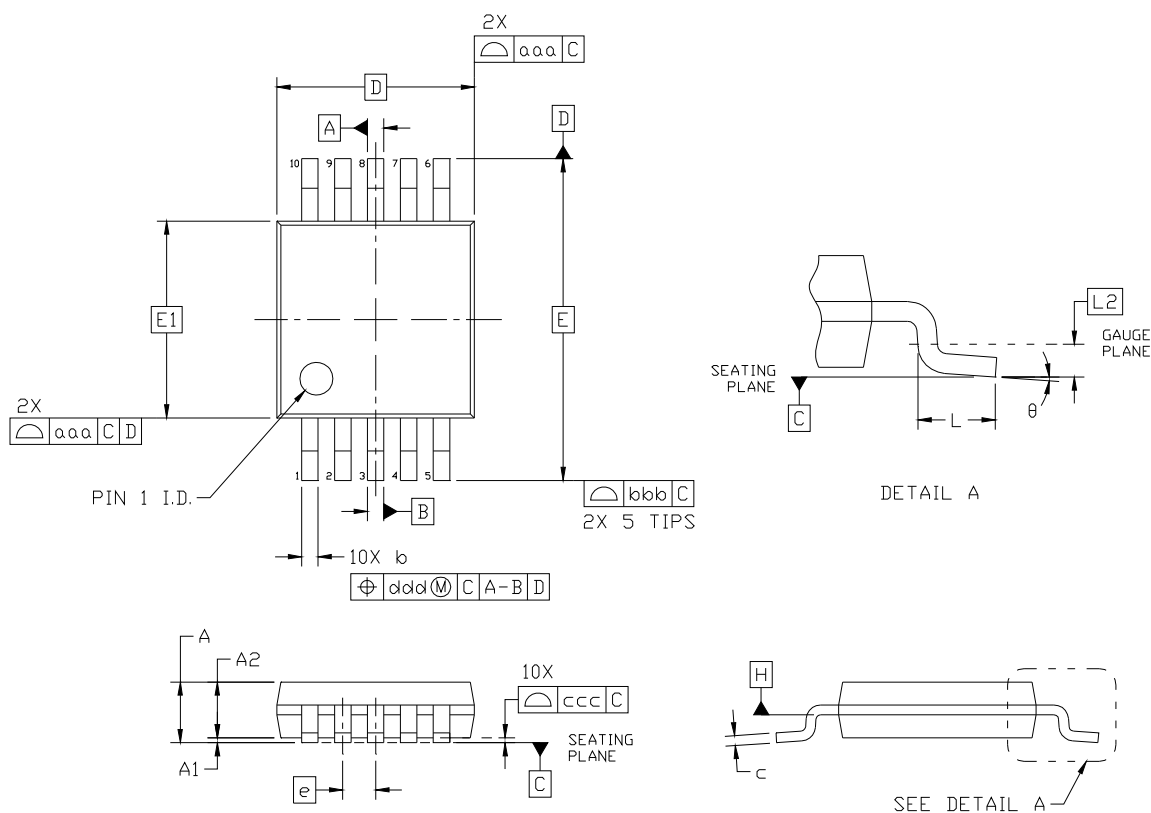
**Table 5.1. SOIC-14 Package Dimensions**

Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	—	—	1.75	L	0.40	—	1.27
A1	0.10	—	0.25	L2	0.25 BSC		
b	0.33	—	0.51	θ	0°	—	8°
c	0.17	—	0.25	aaa	0.10		
D	8.65 BSC			bbb	0.20		
E	6.00 BSC			ccc	0.10		
E1	3.90 BSC			ddd	0.25		
e	1.27 BSC						

**Notes:**

1. All dimensions shown are in millimeters (mm).
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC outline MS012, variation AB.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

## 6. MSOP-10 Package Specifications



**Figure 6.1. MSOP-10 Package Drawing**

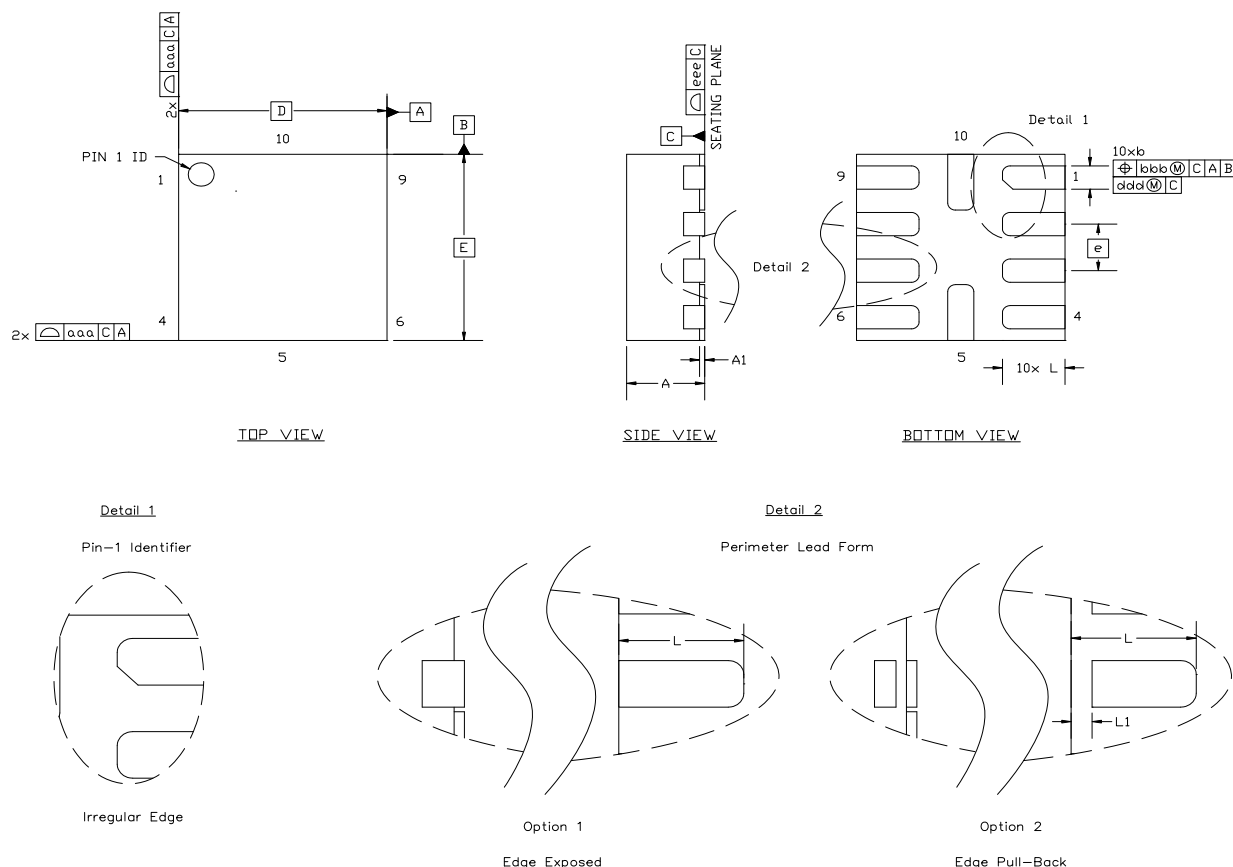
**Table 6.1. MSOP-10 Package Dimensions**

Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	—	—	1.10	e	—	0.50 BSC	—
A1	0.00	—	0.15	L	0.40	0.60	0.80
A2	0.75	0.85	0.95	L2	—	0.25 BSC	—
b	0.17	—	0.33	θ	0°	—	8°
c	0.08	—	0.23	aaa	—	—	0.20
D	—	3.00 BSC	—	bbb	—	—	0.25
E	—	4.90 BSC	—	ccc	—	—	0.10
E1	—	3.00 BSC	—	ddd	—	—	0.08

**Notes:**

1. All dimensions shown are in millimeters (mm).
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC outline MO-187, Variation "BA".
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

## 7. QFN-10 Package Specifications



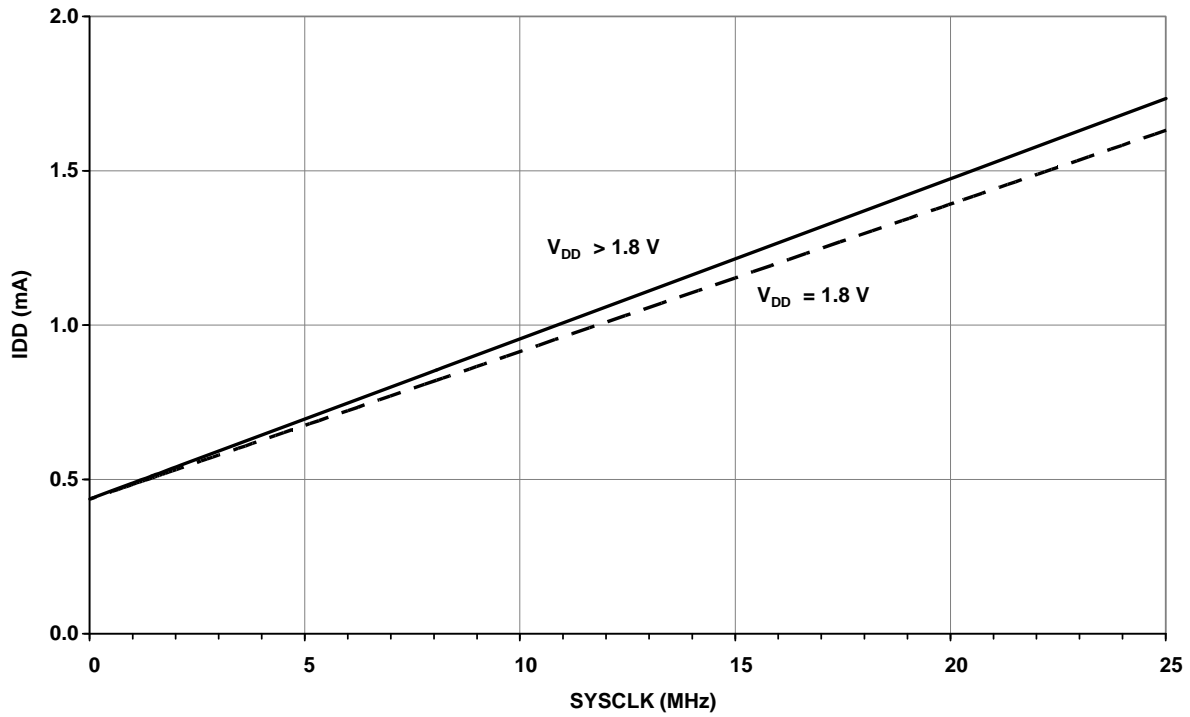
**Figure 7.1. QFN-10 Package Drawing**

**Table 7.1. QFN-10 Package Dimensions**

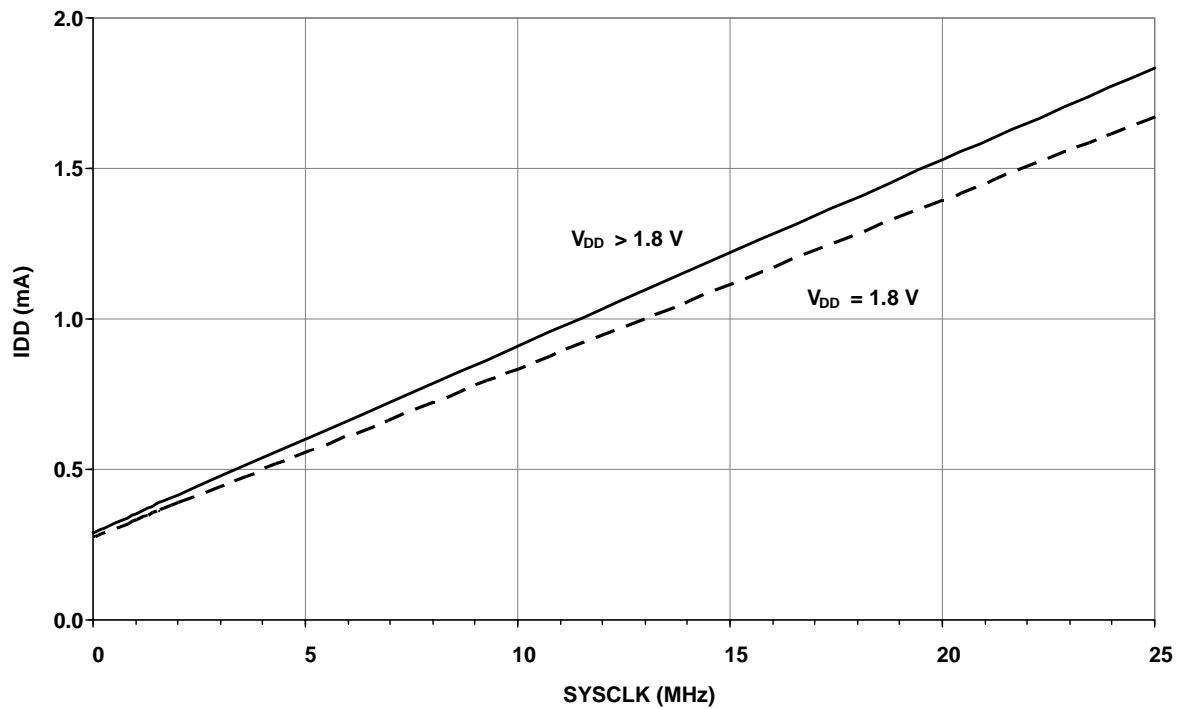
Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	0.70	0.75	0.80	L	0.55	0.60	0.65
A1	0.00	—	0.05	L1	—	—	0.15
b	0.18	0.25	0.30	aaa	—	—	0.10
D	2.00 BSC.			bbb	—	—	0.10
e	0.50 BSC.			ccc	—	—	0.05
E	2.00 BSC.			ddd	—	—	0.08

**Notes:**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC outline MO-220, variation WCCD-5 except for feature L which is toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.



**Figure 8.3. C8051T600/1/2/3/4/5 Idle Mode Supply Current vs. Frequency (MPCE = 1)**



**Figure 8.4. C8051T606 Idle Mode Digital Current vs. Frequency (MPCE = 1)**

# C8051T600/1/2/3/4/5/6

## SFR Definition 9.4. ADC0CN: ADC0 Control

Bit	7	6	5	4	3	2	1	0
Name	AD0EN	AD0TM	AD0INT	AD0BUSY	AD0WINT	AD0CM[2:0]		
Type	R/W	R/W	R/W	R/W	R/W	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE8; Bit-Addressable

Bit	Name	Function
7	AD0EN	<b>ADC0 Enable Bit.</b> 0: ADC0 Disabled. ADC0 is in low-power shutdown. 1: ADC0 Enabled. ADC0 is active and ready for data conversions.
6	AD0TM	<b>ADC0 Track Mode Bit.</b> 0: Normal Track Mode: When ADC0 is enabled, tracking is continuous unless a conversion is in progress. Conversion begins immediately on start-of-conversion event, as defined by AD0CM[2:0]. 1: Delayed Track Mode: When ADC0 is enabled, input is tracked when a conversion is not in progress. A start-of-conversion signal initiates three SAR clocks of additional tracking, and then begins the conversion.
5	AD0INT	<b>ADC0 Conversion Complete Interrupt Flag.</b> 0: ADC0 has not completed a data conversion since AD0INT was last cleared. 1: ADC0 has completed a data conversion.
4	AD0BUSY	<b>ADC0 Busy Bit.</b> <b>Read:</b> 0: ADC0 conversion is not in progress. 1: ADC0 conversion is in progress. <b>Write:</b> 0: No Effect. 1: Initiates ADC0 Conversion if AD0CM[2:0] = 000b
3	AD0WINT	<b>ADC0 Window Compare Interrupt Flag.</b> 0: ADC0 Window Comparison Data match has not occurred since this flag was last cleared. 1: ADC0 Window Comparison Data match has occurred.
2:0	AD0CM[2:0]	<b>ADC0 Start of Conversion Mode Select.</b> 000: ADC0 start-of-conversion source is write of 1 to AD0BUSY. 001: ADC0 start-of-conversion source is overflow of Timer 0. 010: ADC0 start-of-conversion source is overflow of Timer 2. 011: ADC0 start-of-conversion source is overflow of Timer 1. 100: ADC0 start-of-conversion source is rising edge of external CNVSTR. 101: ADC0 start-of-conversion source is overflow of Timer 3. 11x: Reserved.

## 10. Temperature Sensor (C8051T600/2/4 only)

An on-chip temperature sensor is included on the C8051T600/2/4, which can be directly accessed via the ADC multiplexer. To use the ADC to measure the temperature sensor, the ADC mux channel should be configured to connect to the temperature sensor. The temperature sensor transfer function is shown in Figure 10.1. The output voltage ( $V_{TEMP}$ ) is the positive ADC input when the ADC multiplexer is set correctly. The TEMPE bit in register REF0CN enables/disables the temperature sensor, as described in SFR Definition 11.1. While disabled, the temperature sensor defaults to a high impedance state and any ADC measurements performed on the sensor will result in meaningless data. Refer to Table 8.8 for the slope and offset parameters of the temperature sensor.

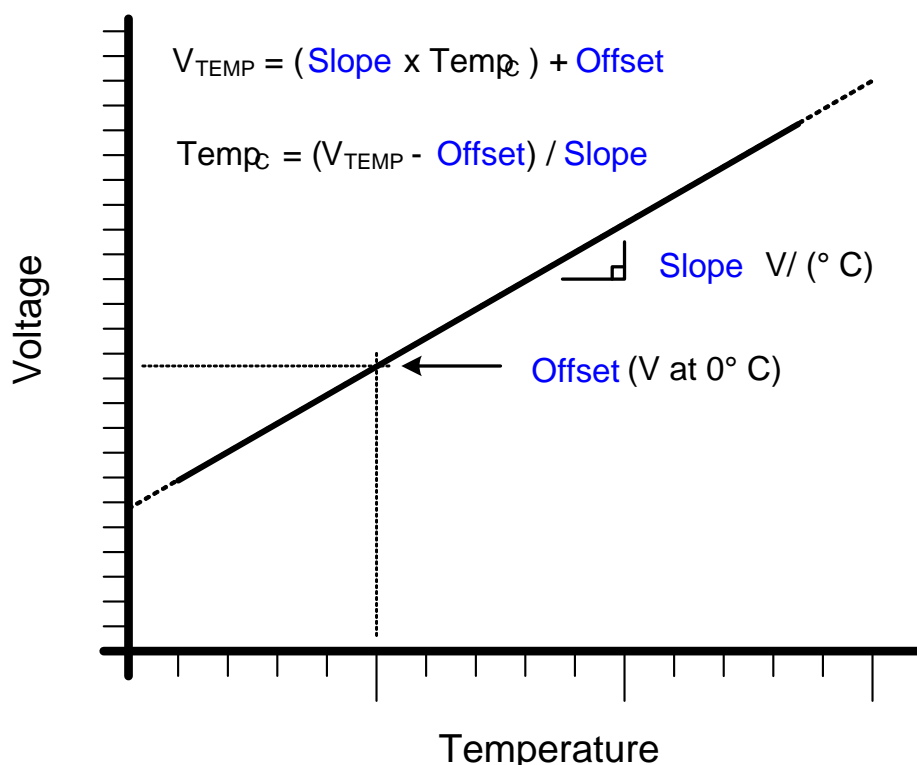


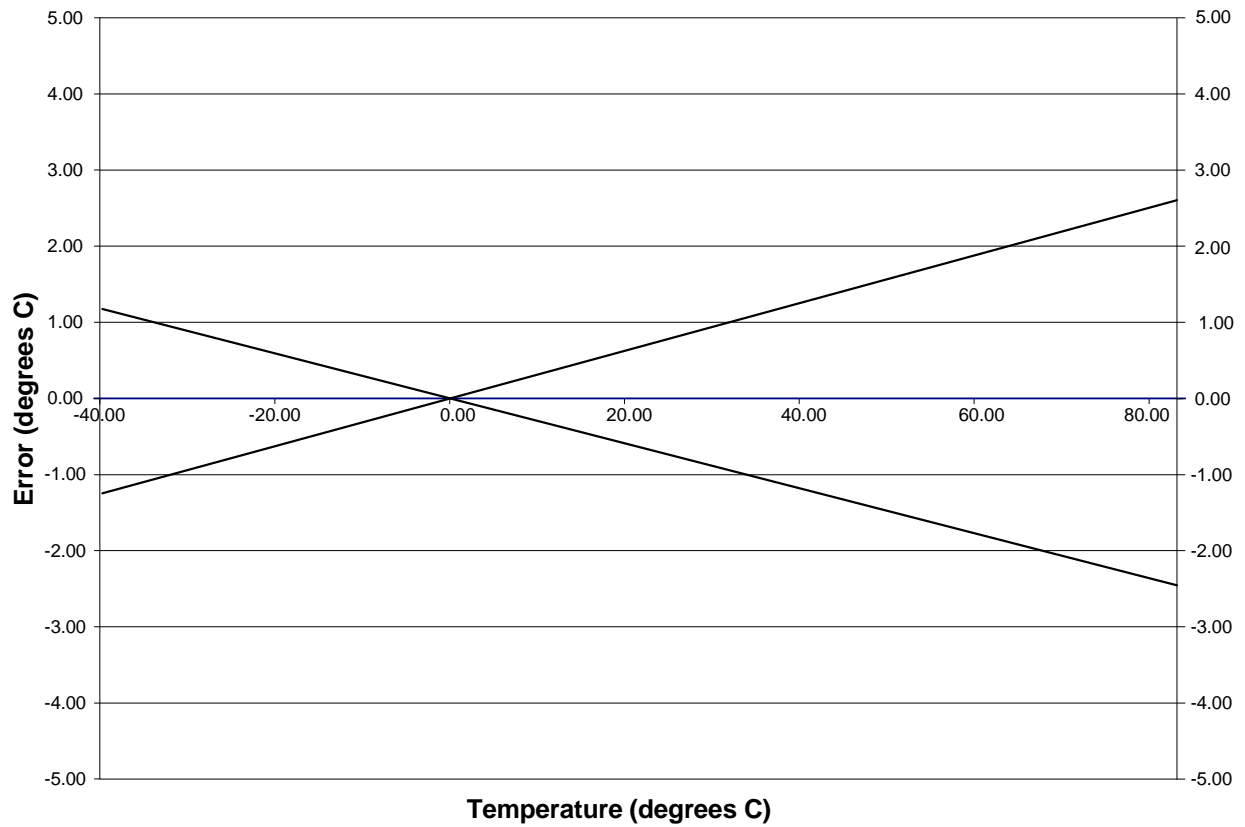
Figure 10.1. Temperature Sensor Transfer Function

### 10.1. Calibration

The uncalibrated temperature sensor output is extremely linear and suitable for relative temperature measurements (see Table 8.8 on page 35 for specifications). For absolute temperature measurements, offset and/or gain calibration is recommended. A single-point offset measurement of the temperature sensor is performed on each device during production test. The registers TOFFH and TOFFL, shown in SFR Definition 10.1 and SFR Definition 10.2 represent the output of the ADC when reading the temperature sensor at 0 °C, and using the internal regulator as a voltage reference.

Figure 10.2 shows the typical temperature sensor error assuming a 1-point calibration at 0 °C. **Parameters that affect ADC measurement, in particular the voltage reference value, will also affect temperature measurement.**





**Figure 10.2. Temperature Sensor Error with 1-Point Calibration at 0 °C**

**SFR Definition 12.1. REG0CN: Voltage Regulator Control**

Bit	7	6	5	4	3	2	1	0
Name	STOPCF	BYPASS						MPCE
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC7

Bit	Name	Function
7	STOPCF	<b>Stop Mode Configuration.</b> This bit configures the regulator's behavior when the device enters STOP mode. 0: Regulator is still active in STOP mode. Any enabled reset source will reset the device. 1: Regulator is shut down in STOP mode. Only the $\overline{\text{RST}}$ pin or power cycle can reset the device.
6	BYPASS	<b>Bypass Internal Regulator.</b> This bit places the regulator in bypass mode, turning off the regulator, and allowing the core to run directly from the $V_{DD}$ supply pin. 0: Normal Mode—Regulator is on. 1: Bypass Mode—Regulator is off, and the microcontroller core operates directly from the $V_{DD}$ supply voltage. <b>IMPORTANT: Bypass mode is for use with an external regulator as the supply voltage only. Never place the regulator in bypass mode when the <math>V_{DD}</math> supply voltage is greater than the specifications given in Table 8.1 on page 30. Doing so may cause permanent damage to the device.</b>
5:1	Reserved	Reserved. Must Write 00000b.
0	MPCE	<b>Memory Power Controller Enable.</b> This bit can help the system save power at slower system clock frequencies (about 2.0 MHz or less) by automatically shutting down the EPROM memory between clocks when information is not being fetched from the EPROM memory. 0: Normal Mode—Memory power controller disabled (EPROM memory is always on). 1: Low Power Mode—Memory power controller enabled (EPROM memory turns on/off as needed). <b>Note:</b> If an external clock source is used with the Memory Power Controller enabled, and the clock frequency changes from slow (<2.0 MHz) to fast (> 2.0 MHz), the EPROM power will turn on, and up to 20 clocks may be "skipped" to ensure that the EPROM power is stable before reading memory.

## 20.3. Program Memory CRC

A CRC engine is included on-chip, which provides a means of verifying EPROM contents once the device has been programmed. The CRC engine is available for EPROM verification even if the device is fully read and write locked, allowing for verification of code contents at any time.

The CRC engine is operated through the C2 debug and programming interface, and performs 16-bit CRCs on individual 256-byte blocks of program memory, or a 32-bit CRC the entire memory space. To prevent hacking and extrapolation of security-locked source code, the CRC engine will only allow CRCs to be performed on contiguous 256-byte blocks beginning on 256-byte boundaries (lowest 8-bits of address are 0x00). For example, the CRC engine can perform a CRC for locations 0x0400 through 0x04FF, but it cannot perform a CRC for locations 0x0401 through 0x0500, or on block sizes smaller or larger than 256 bytes.

### 20.3.1. Performing 32-bit CRCs on Full EPROM Content

A 32-bit CRC on the entire EPROM space is initiated by writing to the CRC1 byte over the C2 interface. The CRC calculation begins at address 0x0000 and ends at the end of user EPROM space. The EPBusy bit in register C2ADD will be set during the CRC operation, and cleared once the operation is complete. The 32-bit results will be available in the CRC3-0 registers. CRC3 is the MSB, and CRC0 is the LSB. The polynomial used for the 32-bit CRC calculation is 0x04C11DB7.

**Note:** If a 16-bit CRC has been performed since the last device reset, a device reset should be initiated before performing a 32-bit CRC operation.

### 20.3.2. Performing 16-bit CRCs on 256-Byte EPROM Blocks

A 16-bit CRC of individual 256-byte blocks of EPROM can be initiated by writing to the CRC0 byte over the C2 interface. The value written to CRC0 is the high byte of the beginning address for the CRC. For example, if CRC0 is written to 0x02, the CRC will be performed on the 256 bytes beginning at address 0x0200, and ending at address 0x2FF. The EPBusy bit in register C2ADD will be set during the CRC operation, and cleared once the operation is complete. The 16-bit results will be available in the CRC1-0 registers. CRC1 is the MSB, and CRC0 is the LSB. The polynomial for the 16-bit CRC calculation is 0x1021

## 22.2.3. Assigning Port I/O Pins to External Digital Event Capture Functions

External digital event capture functions can be used to trigger an interrupt or wake the device from a low power mode when a transition occurs on a digital I/O pin. The digital event capture functions do not require dedicated pins and will function on both GPIO pins ( $XBR0 = 1$ ) and pins in use by the crossbar ( $XBR0 = 0$ ). External digital event capture functions cannot be used on pins configured for analog I/O. Table 22.3 shows all available external digital event capture functions.

**Table 22.3. Port I/O Assignment for External Digital Event Capture Functions**

Digital Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
External Interrupt 0	P0.0–P0.7	IT01CF
External Interrupt 1	P0.0–P0.7	IT01CF

# C8051T600/1/2/3/4/5/6

## SFR Definition 23.2. SMB0CN: SMBus Control

Bit	7	6	5	4	3	2	1	0
Name	MASTER	TXMODE	STA	STO	ACKRQ	ARBLOST	ACK	SI
Type	R	R	R/W	R/W	R	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC0; Bit-Addressable

Bit	Name	Description	Read	Write
7	MASTER	<b>SMBus Master/Slave Indicator.</b> This read-only bit indicates when the SMBus is operating as a master.	0: SMBus operating in slave mode. 1: SMBus operating in master mode.	N/A
6	TXMODE	<b>SMBus Transmit Mode Indicator.</b> This read-only bit indicates when the SMBus is operating as a transmitter.	0: SMBus in Receiver Mode. 1: SMBus in Transmitter Mode.	N/A
5	STA	<b>SMBus Start Flag.</b>	0: No Start or repeated Start detected. 1: Start or repeated Start detected.	0: No Start generated. 1: When Configured as a Master, initiates a START or repeated START.
4	STO	<b>SMBus Stop Flag.</b>	0: No Stop condition detected. 1: Stop condition detected (if in Slave Mode) or pending (if in Master Mode).	0: No STOP condition is transmitted. 1: When configured as a Master, causes a STOP condition to be transmitted after the next ACK cycle. Cleared by Hardware.
3	ACKRQ	<b>SMBus Acknowledge Request.</b>	0: No Ack requested 1: ACK requested	N/A
2	ARBLOST	<b>SMBus Arbitration Lost Indicator.</b>	0: No arbitration error. 1: Arbitration Lost	N/A
1	ACK	<b>SMBus Acknowledge.</b>	0: NACK received. 1: ACK received.	0: Send NACK 1: Send ACK
0	SI	<b>SMBus Interrupt Flag.</b> This bit is set by hardware under the conditions listed in Table 15.3. SI must be cleared by software. While SI is set, SCL is held low and the SMBus is stalled.	0: No interrupt pending 1: Interrupt Pending	0: Clear interrupt, and initiate next state machine event. 1: Force interrupt.

# C8051T600/1/2/3/4/5/6

## 23.4.3. Data Register

The SMBus Data register SMB0DAT holds a byte of serial data to be transmitted or one that has just been received. Software may safely read or write to the data register when the SI flag is set. Software should not attempt to access the SMB0DAT register when the SMBus is enabled and the SI flag is cleared to logic 0, as the interface may be in the process of shifting a byte of data into or out of the register.

Data in SMB0DAT is always shifted out MSB first. After a byte has been received, the first bit of received data is located at the MSB of SMB0DAT. While data is being shifted out, data on the bus is simultaneously being shifted in. SMB0DAT always contains the last data byte present on the bus. In the event of lost arbitration, the transition from master transmitter to slave receiver is made with the correct data or address in SMB0DAT.

## SFR Definition 23.3. SMB0DAT: SMBus Data

Bit	7	6	5	4	3	2	1	0
Name	SMB0DAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xC2

Bit	Name	Function
7:0	SMB0DAT[7:0]	<b>SMBus Data.</b> The SMB0DAT register contains a byte of data to be transmitted on the SMBus serial interface or a byte that has just been received on the SMBus serial interface. The CPU can read from or write to this register whenever the SI serial interrupt flag (SMB0CN.0) is set to logic 1. The serial data in the register remains stable as long as the SI flag is set. When the SI flag is not set, the system may be in the process of shifting data in/out and the CPU should not attempt to access this register.

# C8051T600/1/2/3/4/5/6

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## SFR Definition 24.2. SBUF0: Serial (UART0) Port Data Buffer

---

Bit	7	6	5	4	3	2	1	0
Name	SBUF0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x99

Bit	Name	Function
7:0	SBUF0[7:0]	<b>Serial Data Buffer Bits 7–0 (MSB–LSB).</b> This SFR accesses two registers; a transmit shift register and a receive latch register. When data is written to SBUF0, it goes to the transmit shift register and is held for serial transmission. Writing a byte to SBUF0 initiates the transmission. A read of SBUF0 returns the contents of the receive latch.

## SFR Definition 25.6. TH0: Timer 0 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TH0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8C

Bit	Name	Function
7:0	TH0[7:0]	<b>Timer 0 High Byte.</b> The TH0 register is the high byte of the 16-bit Timer 0.

## SFR Definition 25.7. TH1: Timer 1 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TH1[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8D

Bit	Name	Function
7:0	TH1[7:0]	<b>Timer 1 High Byte.</b> The TH1 register is the high byte of the 16-bit Timer 1.



## 26.3.4. Frequency Output Mode

Frequency Output Mode produces a programmable-frequency square wave on the module's associated CEXn pin. The Capture/Compare module high byte holds the number of PCA clocks to count before the output is toggled. The frequency of the square wave is then defined by Equation 26.1.

$$F_{CEXn} = \frac{F_{PCA}}{2 \times PCA0CPHn}$$

Note: A value of 0x00 in the PCA0CPHn register is equal to 256 for this equation.

### Equation 26.1. Square Wave Frequency Output

Where  $F_{PCA}$  is the frequency of the clock selected by the CPS2–0 bits in the PCA mode register, PCA0MD. The lower byte of the capture/compare module is compared to the PCA counter low byte; on a match, CEXn is toggled and the offset held in the high byte is added to the matched value in PCA0CPLn. Frequency Output Mode is enabled by setting the ECOMn, TOGn, and PWMn bits in the PCA0CPMn register. Note that the MATn bit should normally be set to 0 in this mode. If the MATn bit is set to 1, the CCFn flag for the channel will be set when the 16-bit PCA0 counter and the 16-bit capture/compare register for the channel are equal.

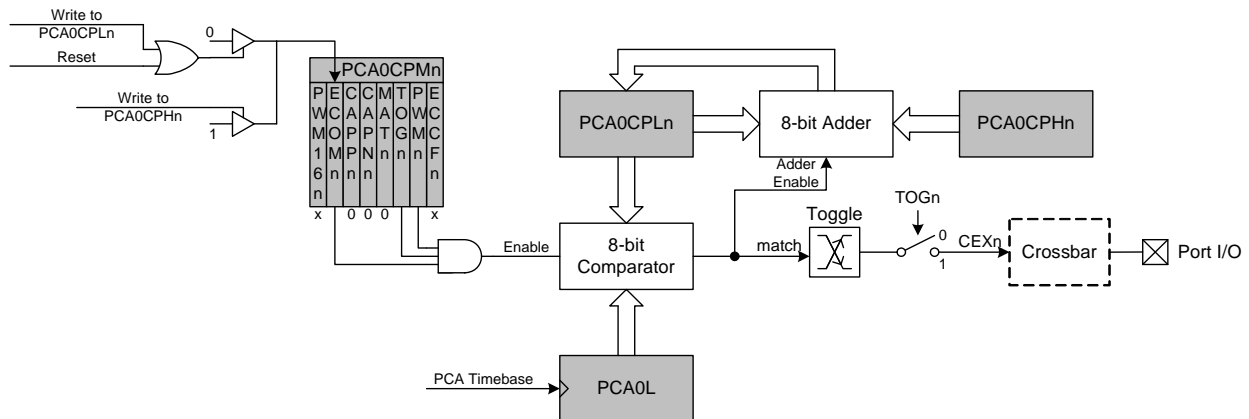


Figure 26.7. PCA Frequency Output Mode

## 26.4. Watchdog Timer Mode

A programmable Watchdog Timer (WDT) function is available through the PCA Module 2. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH2) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

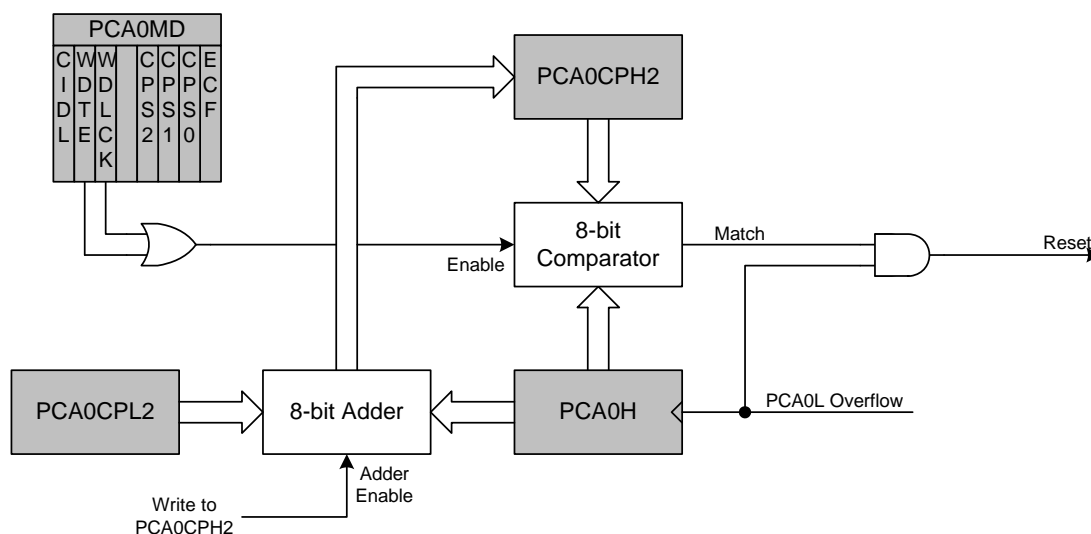
With the WDTE bit set in the PCA0MD register, Module 2 operates as a Watchdog Timer (WDT). The Module 2 high byte is compared to the PCA counter high byte; the Module 2 low byte holds the offset to be used when WDT updates are performed. **The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled.** The WDT will generate a reset shortly after code begins execution. To avoid this reset, the WDT should be explicitly disabled (and optionally re-configured and re-enabled if it is used in the system).

### 26.4.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS2–CPS0) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 2 is forced into software timer mode.
- Writes to the Module 2 mode register (PCA0CPM2) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control bit (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH2 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH2. Upon a PCA0CPH2 write, PCA0H plus the offset held in PCA0CPL2 is loaded into PCA0CPH2 (See Figure 26.10).



**Figure 26.10. PCA Module 2 with Watchdog Timer Enabled**

## C2 Register Definition 27.2. DEVICEID: C2 Device ID

Bit	7	6	5	4	3	2	1	0
Name	DEVICEID[7:0]							
Type	R/W							
Reset	0	0	0	1	0	1	1	1

C2 Address: 0x00

Bit	Name	Function
7:0	DEVICEID[7:0]	<b>Device ID.</b> This read-only register returns the 8-bit device ID: 0x10 = C8051T600/1/2/3/4/5 0x1B = C8051T606

## C2 Register Definition 27.3. REVID: C2 Revision ID

Bit	7	6	5	4	3	2	1	0
Name	REVID[7:0]							
Type	R/W							
Reset	Varies	Varies	Varies	Varies	Varies	Varies	Varies	Varies

C2 Address: 0x01

Bit	Name	Function
7:0	REVID[7:0]	<b>Revision ID.</b> This read-only register returns the 8-bit revision ID. For example: 0x00 = Revision A.

## DOCUMENT CHANGE LIST

### Revision 0.5 to Revision 1.0

- Updated electrical specification tables based on test, characterization, and qualification data.
- Updated with new formatting standards.
- Corrected minor typographical errors throughout document.
- Updated wording from “OTP EPROM” to “EPROM” throughout document.
- Added information on C2 EPSTAT Register.
- Updated EPROM programming sequence.
- Added Note about 100% Tin (Sn) lead finish to ordering information table.

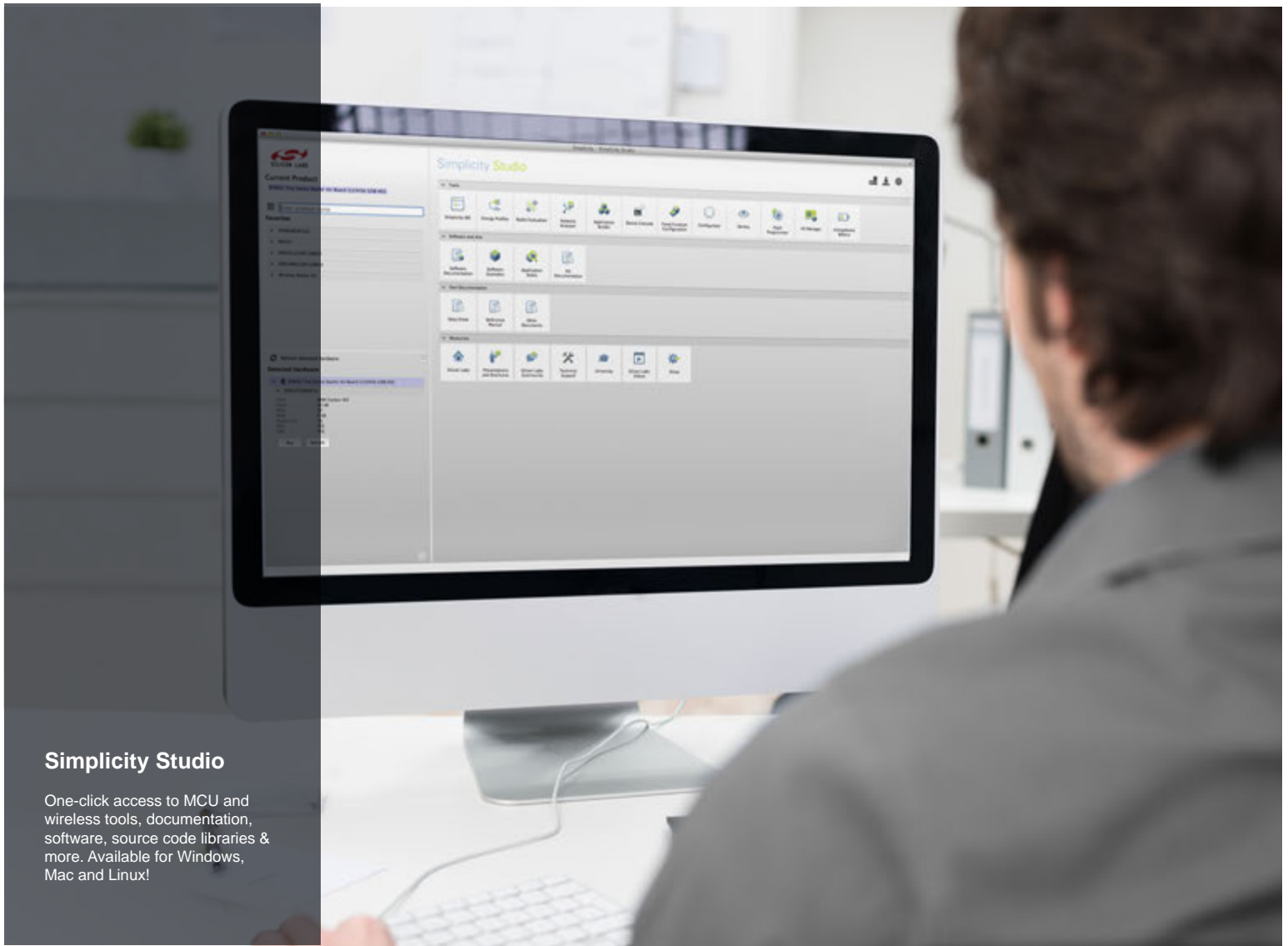
Updated packaging information to include JEDEC-standard drawings for package and land diagram.

### Revision 1.0 to Revision 1.1

Added C8051T606 device information.

### Revision 1.1 to Revision 1.2

- Updated Table 8.4 on page 34.



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